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SHAY

CRCW-HP e3

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TYPE / SIZE	TCR	TOLERANCE	RESISTANCE	E-SERIES
	± 200 ppm/K	±5%	1 Ω to 1 MΩ	E24
CRCW0402-HP e3	± 100 ppm/K	± 1 % ± 0.5 %	1 Ω to 1 M Ω	E24; E96
	Jumper, I _{max.} = 3 A	≤ 10 mΩ	0 Ω	-
	± 200 ppm/K	± 5 %	1 Ω to 1 MΩ	E24
CRCW0603-HP e3	± 100 ppm/K	± 1 % ± 0.5 %	1 Ω to 1 MΩ	E24; E96
	Jumper, I _{max.} = 5 A	≤8 mΩ	0 Ω	-
	± 200 ppm/K	±5%	1 Ω to 1 MΩ	E24
CRCW0805-HP e3	± 100 ppm/K	± 1 % ± 0.5 %	1 Ω to 1 MΩ	E24; E96
	Jumper, I _{max.} = 6 A	≤ 5 mΩ	0 Ω	-
CRCW1206-HP e3	± 200 ppm/K	± 5 %	1 Ω to 1 MΩ	E24
	± 100 ppm/K	± 1 % ± 0.5 %	1 Ω to 1 MΩ	E24; E96
	Jumper, I _{max.} = 10 A	≤ 5 mΩ	0 Ω	-
	± 200 ppm/K	± 5 %	1 Ω to 1 MΩ	E24
CRCW1210-HP e3	± 100 ppm/K	± 1 % ± 0.5 %	1Ω to $1 M\Omega$	E24; E96
	Jumper, I _{max.} = 12 A	$\leq 4 \text{ m}\Omega$	0 Ω	-
	± 200 ppm/K	± 5 %	1 Ω to 1 MΩ	E24
RCW1218-HP e3	± 100 ppm/K	± 1 % ± 0.5 %	1 Ω to 1 MΩ	E24; E96
ľ	Jumper, I _{max.} = 20 A	$\leq 4 \text{ m}\Omega$	0 Ω	-
	± 200 ppm/K	±5%	1 Ω to 1 MΩ	E24
CRCW2010-HP e3	± 100 ppm/K	± 1 % ± 0.5 %	1 Ω to 1 MΩ	E24; E96
ľ	Jumper, I _{max.} = 12 A	≤ 5 mΩ	0 Ω	-
	± 200 ppm/K	± 5 %	1 Ω to 1 MΩ	E24
CRCW2512-HP e3	± 100 ppm/K	± 1 % ± 0.5 %	1 Ω to 1 MΩ	E24; E96
	Jumper, I _{max.} = 16 A	$\leq 5 \text{ m}\Omega$	0 Ω	-

• The temperature coefficient of resistance (TCR) is not specified for 0 Ω jumpers

PACKAGING						
TYPE / SIZE	CODE	QUANTITY	PACKAGING STYLE	WIDTH	РІТСН	PACKAGING DIMENSIONS
CRCW0402-HP e3	ED = ET7	10 000			2 mm	Ø 180 mm / 7"
	EE = EF4	50 000				Ø 330 mm / 13"
	EI = ET2	5000				Ø 180 mm / 7"
	ED = ET3	10 000			2 mm	Ø 180 mm / 7"
	EL = ET4	20 000			2 11111	Ø 285 mm / 11.25
CRCW0603-HP e3	EE = ET8	20 000				Ø 330 mm / 13"
	EA = ET1	5000			4 mm	Ø 180 mm / 7"
	EB = ET5	10 000		8 mm		Ø 285 mm / 11.25
	EC = ET6	20 000	Paper tape acc. to IEC 60286-3, type 1a			Ø 330 mm / 13"
CRCW0805-HP e3	EA = ET1	5000			4 mm	Ø 180 mm / 7"
	EB = ET5	10 000				Ø 285 mm / 11.25
	EC = ET6	20 000				Ø 330 mm / 13"
CRCW1206-HP e3	EA = ET1	5000			4 mm	Ø 180 mm / 7"
	EB = ET5	10 000				Ø 285 mm / 11.25
	EC = ET6	20 000				Ø 330 mm / 13"
	EA = ET1	5000	-		4 mm	Ø 180 mm / 7"
CRCW1210-HP e3	EB = ET5	10 000				Ø 285 mm / 11.25
	EC = ET6	20 000				Ø 330 mm / 13"
CRCW1218-HP e3	EK = ET9	4000			4 mm	Ø 180 mm / 7"
CRCW2010-HP e3	EF = E02	4000	Blister tape acc. to	12 mm	4 mm 4 mm 8 mm	Ø 180 mm / 7"
	EJ = E08	16 000				Ø 330 mm / 13"
	EG = E67	2000	IEC 60286-3, type 2a			(X 100 mm / 7"
CRCW2512-HP e3	EH = E82	4000	1		4 mm	Ø 180 mm / 7"

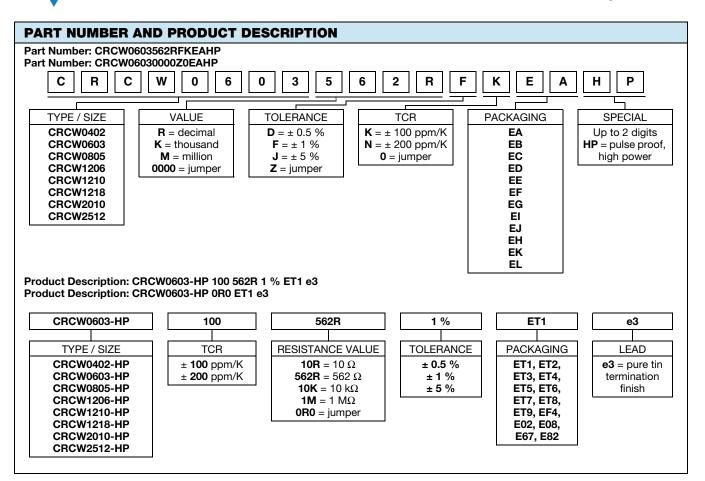
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2 For technical questions, contact: thickfilmchip@vishay.com Document Number: 20043

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CRCW-HP e3

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DESCRIPTION

Production is strictly controlled and follows an extensive set of instructions established for reproducibility. A cermet film layer and a glass-over are deposited on both sides of a high grade (Al_2O_3) ceramic substrate with its prepared inner contacts on both sides. A special laser is used to achieve the target value by smoothly fine trimming the resistive layer without damaging the ceramics. The resistor elements are covered by a protective coating designed for electrical, mechanical and climatic protection. The terminations receive a final pure tin on nickel plating.

The result of the determined production is verified by an extensive testing procedure on 100 % of the individual chip resistors. Only accepted products are laid directly into the tape in accordance with **IEC 60286-3 Type 1a and Type 2a** ⁽¹⁾.

ASSEMBLY

The resistors are suitable for processing on automatic SMD assembly systems. They are suitable for automatic soldering wave, reflow or vapor phase as shown in **IEC 61760-1** ⁽¹⁾. The encapsulation is resistant to all cleaning solvents commonly used in the electronics industry, including alcohols, esters and aqueous solutions. The suitability of conformal coatings, potting compounds and their processes, if applied, shall be qualified by appropriate means to ensure the long-term stability of the whole system.

The resistors are RoHS-compliant, the pure tin plating provides compatibility with lead (Pb)-free and lead-containing soldering processes. Solderability is specified for 2 years after production or requalification. The permitted storage time is 20 years. The immunity of the plating against tin whisker growth has been proven under extensive testing.

MATERIALS

Vishay acknowledges the following systems for the regulation of hazardous substances:

- IEC 62474, Material Declaration for Products of and for the Electrotechnical Industry, with the list of declarable substances given therein ⁽²⁾
- The Global Automotive Declarable Substance List (GADSL) ⁽³⁾
- The REACH regulation (1907/2006/EC) and the related list of substances with very high concern (SVHC) ⁽⁴⁾ for its supply chain

The products do not contain any of the banned substances as per IEC 62474, GADSL, or the SVHC list, see <u>www.vishay.com/how/leadfree</u>.

Hence the products fully comply with the following directives:

- 2000/53/EC End-of-Life Vehicle Directive (ELV) and Annex II (ELV II)
- 2011/65/EU Restriction of the Use of Hazardous Substances Directive (RoHS) with amendment 2015/863/EU
- 2012/19/EU Waste Electrical and Electronic Equipment Directive (WEEE)

Vishay pursues the elimination of conflict minerals from its supply chain, see the Conflict Minerals Policy at <u>www.vishay.com/doc?49037</u>.

APPROVALS

The resistors are qualified according to AEC-Q200.

Where applicable, the resistors are tested in accordance with **EN 140401-802** which refers to **EN 60115-1**, **EN 60115-8** and the variety of environmental test procedures of the **IEC 60068** ⁽¹⁾ series.

RELATED PRODUCTS

For more information about products with superior surge and pulse performance please refer to datasheet: D/CRCW-IF e3, Pulse Proof Thick Film Chip Resistors www.vishay.com/doc?20024.

For thick film resistors with standard requirements for power rating, please refer to datasheet:

D/CRCW e3, Standard Thick Film Chip <u>www.vishay.com/doc?20035</u>.

For anti-surge products and high power rating, please refer to datasheet:

RCS e3, Anti-Surge High Power Thick Film Chip Resistors <u>www.vishay.com/doc?20065</u>.

Notes

- (1) The quoted IEC standards are also released as EN standards with the same number and identical contents
- (2) The IEC 62474 list of declarable substances is maintained in a dedicated database, which is available at http://std.iec.ch/iec62474
- (3) The Global Automotive Declarable Substance List (GADSL) is maintained by the American Chemistry Council and available at <u>www.gadsl.org</u>
- ⁽⁴⁾ The SVHC list is maintained by the European Chemical Agency (ECHA) and available at <u>http://echa.europa.eu/candidate-list-table</u>

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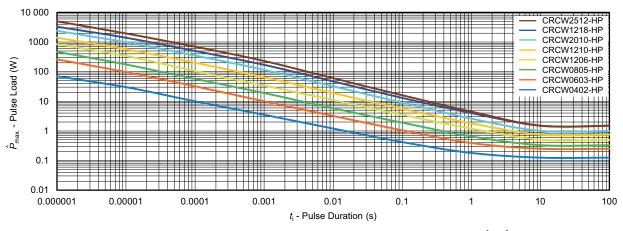
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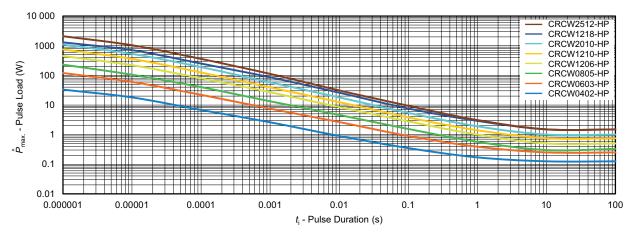
FUNCTIONAL PERFORMANCE

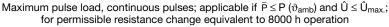
Single Pulse

Continuous Pulse



Maximum pulse load, single pulse; applicable if $\bar{P} \rightarrow 0$ and n < 1000 and $\hat{U} \le \hat{U}_{max}$; for permissible resistance change equivalent to 8000 h operation





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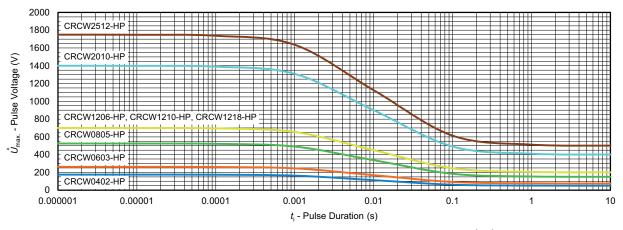
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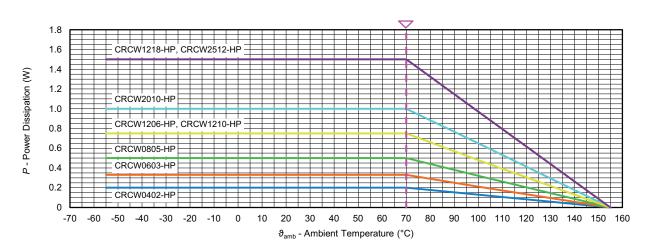
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Pulse Voltage



Maximum pulse voltage, single and continuous pulses; applicable if $\hat{P} \leq \hat{P}_{max.}$; for permissible resistance change equivalent to 8000 h operation

Derating



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TESTS AND REQUIREMENTS

All executed tests are carried out in accordance with the following specifications:

EN 60115-1, generic specification

EN 60115-8 (successor of EN 140400), sectional specification

EN 140401-802, detail specification

IEC 60068-2-xx, test methods

The parameters stated in the Test Procedures and Requirements table are based on the required tests and permitted limits of EN 140401-802. The table presents only the most important tests, for the full test schedule refer to the documents listed above. However, some additional tests and a number of improvements against those minimum requirements have been included. The testing also covers most of the requirements specified by EIA/IS-703 and JIS-C-5201-1.

The tests are carried out under standard atmospheric conditions in accordance with IEC 60068-1, 4.3, whereupon the following values are applied:

Temperature: 15 °C to 35 °C

Relative humidity: 25 % to 75 %

Air pressure: 86 kPa to 106 kPa (860 mbar to 1060 mbar).

A climatic category LCT / UCT / 56 is applied, defined by the lower category temperature (LCT), the upper category temperature (UCT), and the duration of exposure in the damp heat, steady state test (56 days).

The components are mounted for testing on boards in accordance with EN 60115-8, 2.4.2 unless otherwise specified.

TEST PROCEDURES AND REQUIREMENTS							
EN 60115-1 CLAUSE	IEC 60068-2 ⁽¹⁾ TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (∆ <i>R</i>)			
			Stability for product types:	STABILITY CLASS 2 OR BETTER			
			CRCW-HP e3	1 Ω to 1 MΩ			
4.5	-	Resistance	-	± 0.5 %; ± 1 %; ± 5 %			
4.8	-	Temperature coefficient	(20 / -55 / 20) °C and (20 / 155 / 20) °C	± 100 ppm/K; ± 200 ppm/K			
4.25.1	_	Endurance at 70 °C	$U = \sqrt{P_{70} \times R} \text{ or } U = U_{\text{max.}};$ whichever is the less severe; 1.5 h on; 0.5 h off				
4.23.1	_	Endurance at 70 C	70 °C; 1000 h	\pm (2 % R + 0.1 Ω)			
			70 °C; 8000 h	\pm (4 % R + 0.1 Ω)			
4.25.3	-	Endurance at upper category temperature	155 °C, 1000 h	± (2 % <i>R</i> + 0.1 Ω)			
4.24	78 (Cab)	Damp heat, steady state	(40 ± 2) °C; 56 days; (93 ± 3) % RH;	± (1 % <i>R</i> + 0.05 Ω)			
4.37	67 (Cy)	Damp heat, steady state, accelerated	$ \begin{array}{l} (85 \pm 2) \ ^{\circ}\text{C}; \ (85 \pm 5) \ \% \ \text{RH}; \\ U = \sqrt{0.1 \ x \ P_{85} \ x \ R} \ \leq 100 \ \text{V}; \\ 1000 \ \text{h} \end{array} $	± (2 % <i>R</i> + 0.1 Ω)			
4.23	-	Climatic sequence:	-				
4.23.2	2 (Bb)	dry heat	125 °C; 16 h				
4.23.3	30 (Db)	damp heat, cyclic	55 °C; 24 h; ≥ 90 % RH; 1 cycle				
4.23.4	1 (Ab)	cold	-55 °C; 2 h	± (2 % <i>R</i> + 0.1 Ω)			
4.23.5	13 (M)	low air pressure	8.5 kPa; 2 h; (25 ± 10) °C				
4.23.6	30 (Db)	damp heat, cyclic	55 °C; 24 h; ≥ 90 % RH; 5 cycles				
4.23.7	-	DC load	$U = \sqrt{P_{70} \times R} \le U_{\text{max.;}}$ 1 min				
-	1 (Aa)	Cold	-55 °C; 2 h	± (0.5 % <i>R</i> + 0.05 Ω)			

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TEST PR	OCEDUR	ES AND REQUIR	EMENTS	
EN 60115-1 CLAUSE	IEC 60068-2 ⁽¹⁾ TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (∆ <i>R</i>)
		Stability for product types:	STABILITY CLASS 2 OR BETTER	
			CRCW-HP e3	1 Ω to 1 MΩ
4.19	14 (Na)	Rapid change of temperature	30 min at -55 °C and 30 min at 125 °C; 1000 cycles	± (1 % <i>R</i> + 0.05 Ω) no visible damage
4.13	-	Short time overload	$U = 2.5 \text{ x } \sqrt{P_{70} \text{ x } R} \le 2 \text{ x } U_{\text{max.};}$ whichever is the less severe; 5 s	± (2 % <i>R</i> + 0.05 Ω)
4.27	-	Single pulse high voltage overload	Severity no. 4: $U = 10 \times \sqrt{P_{70} \times R}$ or $U = 2 \times U_{max.;}$ whichever is the less severe; 10 pulses 10 µs/700 µs	± (1 % <i>R</i> + 0.05 Ω) no visible damage
4.39	-	Periodic electric overload	$U = \sqrt{15 \times P_{70} \times R} \text{ or}$ $U = 2 \times U_{\text{max.;}}$ whichever is the less severe; 0.1 s on; 2.5 s off; 1000 cycles	± (1 % <i>R</i> + 0.05 Ω) no visible damage
4.38	-	Electrostatic discharge (human body model)	IEC 61340-3-1 ⁽¹⁾ ; 3 pos. + 3 neg. discharges; ESD voltage acc. to the size	± (1 % <i>R</i> + 0.05 Ω)
4.22	6 (Fc)	Vibration	Endurance by sweeping; 10 Hz to 2000 Hz; no resonance; amplitude \leq 1.5 mm or \leq 200 m/s ² ; 7.5 h	± (0.5 % <i>R</i> + 0.05 Ω) no visible damage
4.17	58 (Td)	Solderability	Solder bath method; Sn60Pb40 non-activated flux; (235 ± 5) °C; (2 ± 0.2) s Solder bath method; Sn96.5Ag3Cu0.5 non-activated flux;	Good tinning (≥ 95 % covered) no visible damage
			$(245 \pm 5) °C;$ $(3 \pm 0.3) s$ Solder bath method	
4.18	58 (Td)	Resistance to soldering heat	(260 ± 5) °C; (10 ± 1) s	± (0.5 % <i>R</i> + 0.05 Ω)
4.29	45 (XA)	Component solvent resistance	lsopropyl alcohol; +50 °C; method 2	No visible damage
4.32	21 (Uu ₃)	Shear (adhesion)	CRCW0402-HP and CRCW0603-HP: 9 N CRCW0805-HP to CRCW2512-HP: 45 N	No visible damage
4.33	21 (Uu ₁)	Substrate bending	Depth 2 mm; 3 times	\pm (0.25 % R + 0.05 Ω) no visible damage, no open circuit in bent position
4.7	-	Voltage proof	<i>U</i> = 1.4 x <i>U</i> _{ins} ; 60 s	No flashover or breakdown
4.35	-	Flammability, needle flame test	IEC 60695-11-5 ⁽¹⁾ ; 10 s	No burning after 30 s

Note

⁽¹⁾ The quoted IEC standards are also released as EN standards with the same number and identical contents

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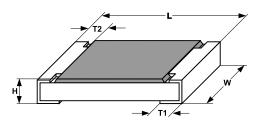
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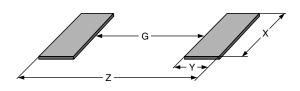
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DIMENSIONS



DIMENSIONS AND MASS								
TYPE / SIZE	L (mm)	W (mm)	H (mm)	T1 (mm)	T2 (mm)	MASS (mg)		
CRCW0402-HP e3	1.0 ± 0.05	0.5 ± 0.05	0.3 ± 0.10	0.25 ± 0.10	0.2 ± 0.10	0.65		
CRCW0603-HP e3	1.6 ± 0.10	0.85 ± 0.10	0.45 ± 0.10	0.3 ± 0.20	0.3 ± 0.20	2		
CRCW0805-HP e3	2.0 ± 0.15	1.25 ± 0.15	0.5 ± 0.10	0.4 ± 0.20	0.35 ± 0.20	5.5		
CRCW1206-HP e3	3.1 ± 0.20	1.6 ± 0.15	0.5 ± 0.15	0.5 ± 0.20	0.45 ± 0.20	10		
CRCW1210-HP e3	3.2 ± 0.20	2.5 ± 0.20	0.6 ± 0.10	0.45 ± 0.20	0.4 ± 0.20	18		
CRCW1218-HP e3	3.1 ± 0.20	4.6 ± 0.20	0.6 ± 0.10	0.45 ± 0.20	0.4 ± 0.20	31		
CRCW2010-HP e3	5.0 ± 0.15	2.5 ± 0.15	0.6 ± 0.10	0.6 ± 0.20	0.6 ± 0.20	25.5		
CRCW2512-HP e3	6.3 ± 0.20	3.15 ± 0.15	0.6 ± 0.10	0.6 ± 0.20	0.6 ± 0.20	42		

SOLDER PAD DIMENSIONS



RECOMMENDED SOLDER PAD DIMENSIONS								
	WAVE SOLDERING				REFLOW SOLDERING			
TYPE / SIZE	G (mm)	Y (mm)	X (mm)	Z (mm)	G (mm)	Y (mm)	X (mm)	Z (mm)
CRCW0402-HP e3	-	-	-	-	0.45	0.6	0.6	1.65
CRCW0603-HP e3	0.65	1.10	1.25	2.85	0.75	0.75	1.00	2.25
CRCW0805-HP e3	0.90	1.30	1.60	3.50	1.00	0.95	1.45	2.90
CRCW1206-HP e3	1.40	1.40	1.95	4.20	1.50	1.05	1.8	3.60
CRCW1210-HP e3	1.80	1.45	2.95	4.70	1.70	1.10	2.80	3.90
CRCW1218-HP e3	1.60	1.50	5.10	4.60	1.70	1.10	4.90	3.90
CRCW2010-HP e3	3.60	1.65	2.85	6.90	3.70	1.20	2.70	6.10
CRCW2512-HP e3	4.90	1.60	3.50	8.10	5.00	1.25	3.35	7.50

Notes

 The given solder pad dimensions reflect the considerations for board design and assembly as outlined e.g in standards IEC 61188-5-x⁽¹⁾ or in publication IPC-7351.

Still, the given solder pad dimensions will be found adequate for most general applications

⁽¹⁾ The quoted IEC standards are also released as EN standards with the same number and identical contents



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CRCW120615K0FKEAHP CRCW12061R00JN	NEAHP CRCW120610R0FKEAHP CRCW12061K00FKEAH	<u>IP</u>
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CRCW06031R00JNEAHP CRCW060320K0FK	KEAHP CRCW060322R0JNEAHP CRCW06032K00FKEAH	<u>IP</u>
CRCW06032R20JNEAHP CRCW060330K9FK	KEAHP CRCW060333R0FKEAHP CRCW060333R2FKEAH	I P
CRCW060347K0FKEAHP CRCW060347R0JN	NEAHP CRCW0603499RFKEAHP CRCW060349R9FKEAH	I P
CRCW06034K22FKEAHP CRCW06034K70FK	KEAHP CRCW06034K75FKEAHP CRCW06034K99FKEAH	IP
CRCW06034R70JNEAHP CRCW060375R0FK	KEAHP CRCW0805100KFKEAHP CRCW0805100RFKEAH	I P
CRCW080510R0FKEAHP CRCW080510R0JN	NEAHP CRCW0805150RFKEAHP CRCW080515K0FKEAH	1 P
CRCW08051K50FKEAHP CRCW08051M00FK	KEAHP CRCW08051R00JNEAHP CRCW080522R0JNEAH	IP
CRCW080527K0FKEAHP CRCW08052K00FK	KEAHP CRCW08052K20FKEAHP CRCW08052R20JNEAH	IP
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